

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX245F, TC74LCX245FK

Low-Voltage Octal Bus Transceiver with 5-V Tolerant Inputs and Outputs

The TC74LCX245 is a high-performance CMOS octal bus transceiver. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

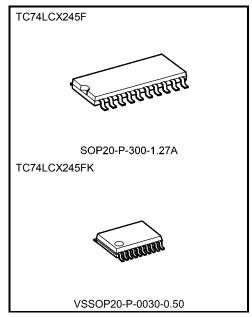
The device is designed for low-voltage $(3.3\ V)\ V_{CC}$ applications, but it could be used to interface to 5-V supply environment for both inputs and outputs.

The direction of data transmission is determined by the level of the DIR input. The enable input (\overline{OE}) can be used to disable the device so that the busses are effectively isolated.

All inputs are equipped with protection circuits against static discharge.

Features (Note)

- Low-voltage operation: $V_{CC} = 1.65$ to 3.6 V
- High-speed operation: $t_{pd} = 7.0 \text{ ns (max) (VCC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Ouput current: |IOH|/IOL = 24 mA (min) (VCC = 3.0 V)
- Latch-up performance: $> \pm 500 \text{ mA}$
- Available in JEITA SOP, VSSOP (US)
- Bidirectional interface between 5.0 V and 3.3 V signals
- · Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 245 type



Weight

SOP20-P-300-1.27A : 0.22 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

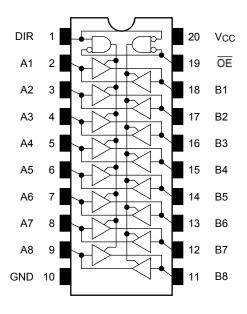
All floating (high impedance) bus pins must have their input levels fixed by means of pull-up or pull-down resistors.

Note: The Electrical Characteristics of V_{CC} = 1.8 \pm 0.15 V is only applicable for products which manufactured from January 2009 onward.

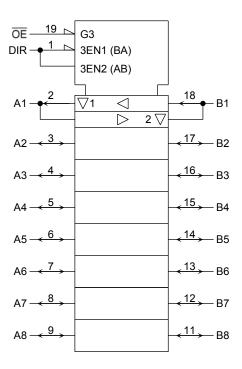
Start of commercial production 1994-03



Pin Assignment (top view)



IEC Logic Symbol



Truth Table

Inputs		Outputa	Function		
ŌĒ	DIR	Outputs	A-Bus	B-Bus	
L	L	A = B	Output	Input	
L	Н	B=A	Input Outpu		
Н	Х	Z	Z		

X: Don't care

Z: High impedance



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	Vcc	-0.5 to 7.0	V
DC input voltage (DIR, $\overline{\text{OE}}$)	VIN	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC bus I/O voltage	VI/O	-0.5 to V _{CC} + 0.5 (Note 3)	V
Input diode current	lık	-50	mA
Output diode current	lok	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	PD	180	mW
DC V _{CC} /ground current	ICC/IGND	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: VOUT < GND, VOUT > VCC

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Dower supply veltage	Vcc	1.65 to 3.6	V	
Power supply voltage	VCC	1.5 to 3.6 (Note 2)	V	
Input voltage (DIR, $\overline{\text{OE}}$)	VIN	0 to 5.5	٧	
Bus I/O voltage	V _{I/O}	0 to 5.5 (Note 3)	V	
Bus I/O voltage	V 1/O	0 to V _{CC} (Note 4)		
Output current	IOH/IOL	±24 (Note 5)	mA	
Output current	IOH/IOL	±12 (Note 6)	ША	
Operating temperature	T _{opr}	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges are required to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either VCC or GND. Please connect both bus inputs and the bus outputs with VCC or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5: VCC = 3.0 to 3.6 V

Note 6: VCC = 2.7 to 3.0 V

Note 7: VIN = 0.8 to 2.0 V, VCC = 3.0 V



Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C)

Characteristics		Symbol	Test Condition Vcc			Min Max		Unit
		Symbol			Vcc (V)	IVIIII	IVIAX	Offic
			_		1.65 to 2.3	V _{CC} × 0.9	_	
	H-level	VIH			2.3 to 2.7	1.7	_	
land to the sec					2.7 to 3.6	2.0	_	.,
Input voltage					1.65 to 2.3	_	Vcc × 0.1	V
	L-level	VIL	_		2.3 to 2.7	_	0.7	
					2.7 to 3.6	_	0.8	
				IOH = -100 μA	1.65 to 3.6	Vcc-0.2	_	
				I _{OH} = -4 mA	1.65	1.05	_	V
	1111	Maria	Maria Maria and Maria	IOH = -8 mA	2.3	1.7	_	
	H-level	Voн	VIN = VIH or VIL	I _{OH} = -12 mA	2.7	2.2	_	
				I _{OH} = -18 mA	3.0	2.4	_	
Outrot valtage				I _{OH} = -24 mA	3.0	2.2	_	
Output voltage			V _{IN} = V _{IH} or V _{IL}	$IOL = 100 \mu A$	1.65 to 3.6	_	0.2	
				I _{OL} = 4 mA	1.65	_	0.45	
	1 11			IOL = 8 mA	2.3	_	0.7	
	L-level	VoL		I _{OL} = 12 mA	2.7	_	0.4	
				I _{OL} = 16 mA	3.0	_	0.4	
				I _{OL} = 24 mA	3.0	_	0.55	
Input leakage current	Input leakage current		V _{IN} = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μΑ
3-state output OFF state current		loz	VIN = VIH or VIL VOUT = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μА
Power-off leakage current		loff	V _{IN} /V _{OUT} = 5.5 V		0	_	10.0	μΑ
Outro and annual annual		Icc	V _{IN} = V _{CC} or GND		1.65 to 3.6	_	10.0	
Quiescent supply cum	Quiescent supply current		V _{IN} /V _{OUT} = 3.6 to 5.5	5 V	1.65 to 3.6	_	±10.0	μΑ
Increase in ICC per inp	out	Δlcc	$V_{IH} = V_{CC} - 0.6 V$ (p	er 1 input)	2.7 to 3.6	_	500	



AC Characteristics (Ta = -40 to 85°C)

Characteristics	Symbol Test Condition			Min	Max	Unit
Characteriotics	Cymbol	rest Schalash	V _{CC} (V)	IVIIII	Wax	Offic
			1.8 ± 0.15	_	25.0	
Dranagation dalay time	tpLH	Figure 1 Figure 2	2.5 ± 0.2	_	9.0	20
Propagation delay time	tpHL	Figure 1, Figure 2	2.7	_	8.0	ns
			3.3 ± 0.3	1.5	7.0	
	t _{pZL} t _{pZH}	Figure 1, Figure 3	1.8 ± 0.15	_	34.0	ns
Outrot and blading			2.5 ± 0.2	_	17.0	
Output enable time			2.7	_	9.5	
			3.3 ± 0.3	1.5	8.5	
	t _{pLZ} t _{pHZ}		1.8 ± 0.15	_	32.0	
			2.5 ± 0.2	_	16.0	ns
Output disable time		Figure 1, Figure 3	2.7	_	8.5	
			3.3 ± 0.3	1.5	7.5	
	tosLH	(Note)	2.7	_	_	
Output to output skew	tosHL		3.3 ± 0.3	_	1.0	ns

Note: Parameter guaranteed by design.

(tosLH = |tpLHm - tpLHn|, tosHL = |tpHLm - tpHLn|)



Dynamic Switching Characteristics (Ta = 25°C, input: tr = tf = 2.5 ns, CL = 50 pF, $RL = 500 \Omega$)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	٧
Quiet output minimum dynamic V _{OL}	Volv	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	٧

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	CIN	DIR, OE	3.3	7	pF
Bus input capacitance	CI/O	An, Bn	3.3	8	pF
Power dissipation capacitance	CPD	f _{IN} = 10 MHz (Not	9) 3.3	25	pF

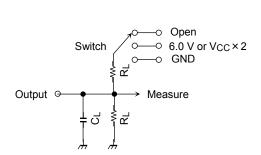
Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

 $ICC (opr) = CPD \cdot VCC \cdot fIN + ICC/8 (per bit)$



AC Test Circuit



Parameter	Switch			
tpLH, tpHL	Open			
t., = t.=	6.0 V	@ $V_{CC} = 3.3 \pm 0.3 \text{ V}$ @ $V_{CC} = 2.7 \text{ V}$		
t _{pLZ} , t _{pZL}	V _{CC} ×2	@ V_{CC} = 2.5 ± 0.2 V @ V_{CC} = 1.8 ± 0.15 V		
tpHZ, tpZH	GND			

Figure 1



AC Waveform

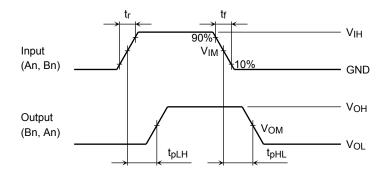


Figure 2 t_{pLH}, t_{pHL}

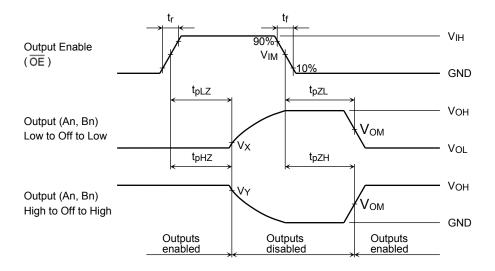


Figure 3 t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}

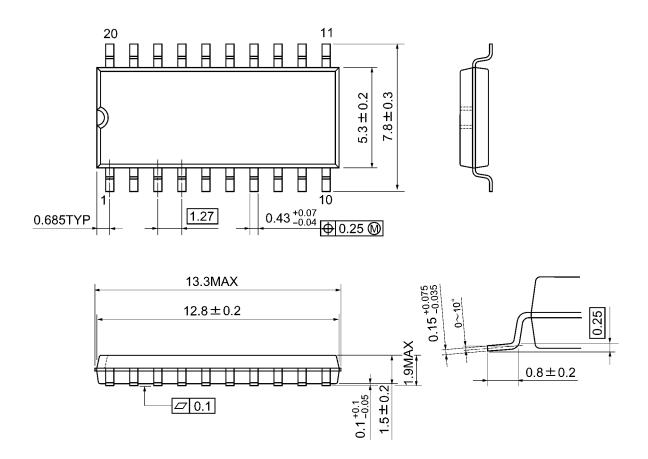
			Vcc				
	Symbol	$3.3 \pm 0.3 \text{ V}$ 2.7 V	2.5 ± 0.2 V	1.8 ± 0.15 V			
Input	VIH	2.7 V	Vcc	Vcc			
	VIM	1.5 V	V _{CC} /2	V _{CC} /2			
	t _r , t _f	2.5 ns	2.0 ns	2.0 ns			
Output	Vом	1.5 V	VoH/2	V _{OH} /2			
	Vx	V _{OL} +0.3 V	V _{OL} +0.15 V	V _{OL} +0.15 V			
	VY	V _{OH} -0.3 V	V _{OL} -0.15 V	V _{OL} -0.15 V			
Load	CL	50 pF	30 pF	30 pF			
	RL	500 Ω	500 Ω	1 kΩ			

2018-08-02



Package Dimensions

SOP20-P-300-1.27A Unit: mm

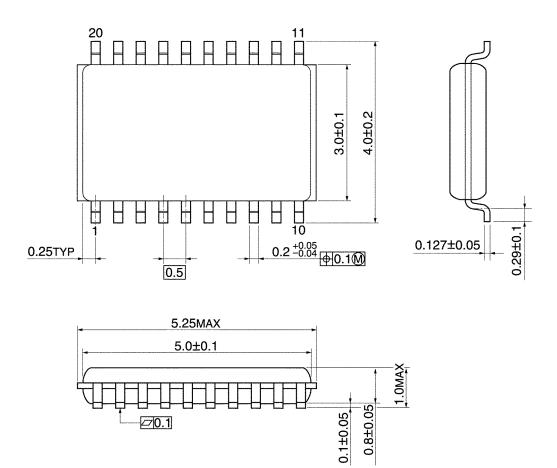


Weight: 0.22 g (typ.)



Package Dimensions

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)



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